

SSL2101

Dimmable GreenChip driver for LED lighting

Rev. 4.1 — 5 December 2011

Product data sheet

1. General description

The SSL2101 is a Switched Mode Power Supply (SMPS) driver IC that operates in combination with a phase cut dimmer directly from the rectified mains. It is designed to drive LED devices. The device includes a high-voltage power switch, a circuit to allow start-up directly from the rectified mains voltage and a high-voltage circuitry to supply the phase cut dimmer.

For dimmer applications, an integrated dedicated circuitry optimizes the dimming curve.

- SSL2101: fully integrated LED driver for lamps up to 10 W
- SSL2102: fully integrated LED driver for lamps up to 25 W
- SSL2103: gives the application designer flexibility to:
 - Use an external power switch to allow the IC to provide any power
 - Use external bleeder transistors to provide extended dimmer interoperability

2. Features and benefits

- Easy migration to existing lighting control infrastructure
- Supports most available dimming solutions
- Optimized efficiency with valley switching managed by a built-in circuitry
- Demagnetization detection
- OverTemperature Protection (OTP)
- Short-Winding Protection (SWP) and OverCurrent Protection (OCP)
- Internal V_{CC} generation allowing start-up from the rectified mains voltage
- Natural dimming curve by logarithmic correction, down to 1 %
- Limited external components required because of the high integration level
- Thermal enhanced SO16 wide body package
- Suitable for flyback and buck applications

3. Applications

- SSL applications below 15 W
- Retro-fit lamps (for example, GU10, E27)
- LED modules such as LED spots, down-lights
- LED strings suitable for retail displays, etc.



Dimmable Greenchip driver for LED lighting

4. Quick reference data

Table 1: Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R_{DSon}	drain-source on-state	power switch; $I_{SOURCE} = -0.50 \text{ A}$				
	resistance	T _j = 25 °C	4.5	6.5	7.5	Ω
		$I_{\text{source}} = -0.20 \text{ A}$				
		T _j = 125 °C	-	9.5	10	Ω
V_{CC}	supply voltage		8.5	-	40	V
f _{osc}	oscillator frequency		10	100	200	kHz
I _{DRAIN}	current on pin DRAIN	V _{DRAIN} > 60 V; no auxiliary supply	-	-	2.2	mA
		V _{DRAIN} > 60 V; with auxiliary supply	-	30	125	μΑ
V_{DRAIN}	voltage on pin DRAIN		40	-	600	V
δ_{min}	minimum duty factor		-	0	-	%
δ_{max}	maximum duty cycle	f = 100 kHz	-	75	-	%
T _{amb}	ambient temperature		-40	-	+100	°C

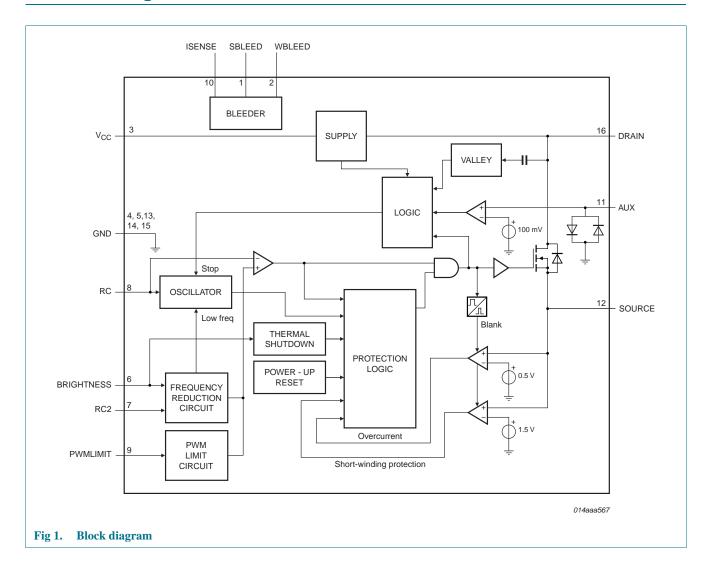
5. Ordering information

Table 2: Ordering information

Type number	Package	ickage									
	Name	Description	Version								
SSL2101T	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1								

Dimmable Greenchip driver for LED lighting

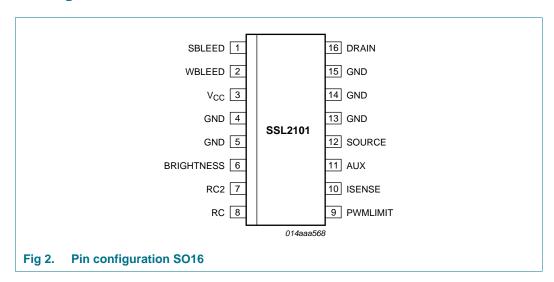
6. Block diagram



Dimmable Greenchip driver for LED lighting

7. Pinning information

7.1 Pinning



7.2 Pin description

Table 3: Pin description

Symbol	Pin	Description
SBLEED	1	drain of internal strong bleeder switch
WBLEED	2	drain of internal weak bleeder switch
V _{CC}	3	supply voltage
GND	4	ground
GND	5	ground
BRIGHTNESS	6	brightness input
RC2	7	setting for frequency reduction
RC	8	frequency setting
PWMLIMIT	9	PWM limit input
ISENSE	10	current sense input for WBLEED
AUX	11	Input for voltage from auxiliary winding for timing (demagnetization)
SOURCE	12	source of internal power switch
GND	13	ground
GND	14	ground
GND	15	ground
DRAIN	16	drain of internal power switch; input for start-up current and valley sensing

Dimmable Greenchip driver for LED lighting

8. Functional description

The SSL2101 is an LED driver IC that operates directly from the rectified mains.

The SSL2101 uses on-time mode control and frequency control to control the LED brightness. The BRIGHTNESS and PWMLIMIT input of the IC can be used to control the LED light output in combination with an external dimmer. The PWMLIMIT input can also be used for Thermal Lumen Management (TLM) and for precision LED current control.

8.1 Start-up and UnderVoltage LockOut (UVLO)

Initially, the IC is self-supplying from the rectified mains voltage. The IC starts switching as soon as the voltage on pin V_{CC} passes the $V_{CC(startup)}$ level. The supply can be taken over by the auxiliary winding of the transformer as soon as V_{CC} is high enough and the supply from the line is stopped for high efficiency operation. Alternatively the IC can be supplied via a bleeder resistor connected to a high voltage. Note however the maximum V_{CC} voltage rating of the IC.

If for some reason the auxiliary supply is not sufficient, the high-voltage supply can also supply the IC. As soon as the voltage on pin V_{CC} drops below the $V_{CC(UVLO)}$ level, the IC stops switching and will restart from the rectified mains voltage, if the internal current delivered is sufficient.

8.2 Oscillator

An internal oscillator inside the IC provides the timing for the switching converter logic.

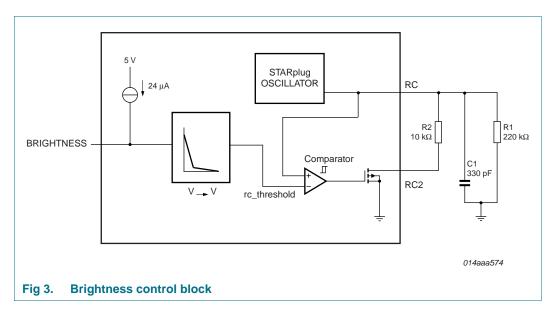
The frequency of the oscillator is set by the external resistors and the capacitor on pin RC and pin RC2. The external capacitor is charged rapidly to the $V_{RC(max)}$ level and, starting from a new primary stroke, it discharges to the $V_{RC(min)}$ level. Because the discharge is exponential, the relative sensitivity of the duty factor to the regulation voltage at low duty factor is almost equal to the sensitivity at high duty factors. This results in a more constant gain over the duty factor range compared to Phase Width Modulated (PWM) systems with a linear sawtooth oscillator. Stable operation at low duty factors is easily realized. The frequency of the converter when $V_{BRIGHTNESS}$ is high can be estimated using Equation 1:

$$RC = \frac{1}{3.5} \cdot \left(\frac{1}{f_{osc}} - t_{charge} \right) \tag{1}$$

R equals the parallel resistance of both oscillator resistors. C is the capacitor connected at the RC pin (pin 8).

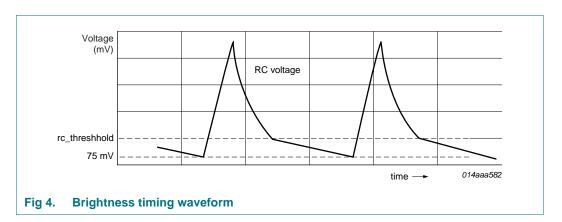
The BRIGHTNESS input controls the frequency reduction mode. Figure 3 shows that the oscillator switches over from an RC curve with R1 in parallel with R2 to R1 only. A low BRIGHTNESS voltage will reduce the switching frequency.

Dimmable Greenchip driver for LED lighting



A typical RC waveform is given in $\underline{\text{Figure 4}}$. The RC switch-over threshold is controlled by the BRIGHTNESS pin.

To ensure that the capacitor can be charged within the charge time, the value of the oscillator capacitor should be limited to 1 nF. Due to leakage current, the value of the resistor connected between the RC pin and the ground should be limited to a maximum of 220 $k\Omega$.



8.3 Duty factor control

The duty factor is controlled by an internally regulated voltage and the oscillator signal on pin RC. The internal regulation voltage is set by the voltage on the PWMLIMIT pin.

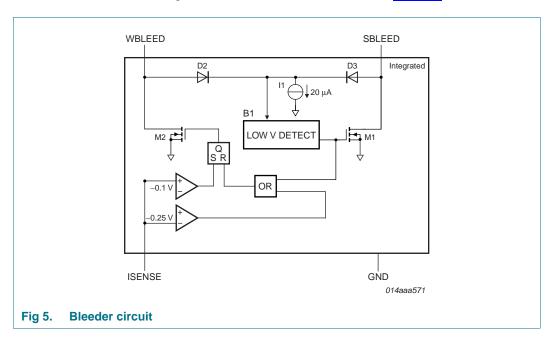
A low PWMLIMIT voltage will results in a low on-time for the internal power switch. The minimum duty factor of the switched mode power supply can be set to 0 %. The maximum duty factor is set to 75 %.

Dimmable Greenchip driver for LED lighting

8.4 Bleeder for dimming applications

The SSL2101 IC contains some circuitry intended for mains dimmer compatibility. This circuit contains two current sinks that are called bleeders. A strong bleeder is used for zero-cross reset of the dimmer and triac latching. A weak bleeder is added to maintain the hold current through the dimmer.

The strong bleeder switch is switched on when the maximum voltage on pin WBLEED and SBLEED is below the $V_{th(SBLEED)}$ level (52 V typically). The weak bleeder switch is switched on as soon as the voltage on pin ISENSE exceeds the $V_{th(high)(ISENSE)}$ level (–100 mV typically). The weak bleeder switch is switched off when the ISENSE voltage drops below the $V_{th(low)(ISENSE)}$ level (–250 mV typically). The weak bleeder switch is also switched off when the strong bleeder switch is switched on. See Figure 5.



8.5 Valley switching

A new cycle is started when the primary switch is switched on (see <u>Figure 6</u>). After a time determined by the oscillator voltage, RC and the internal regulation level, the switch is turned off and the secondary stroke starts. The internal regulation level is determined by the voltage on pin PWMLIMIT.

After the secondary stroke, the drain voltage shows an oscillation with a frequency of approximately:

$$\frac{1}{2 \times \pi \times \sqrt{(L_p \times C_p)}}\tag{2}$$

where:

L_p = primary self inductance

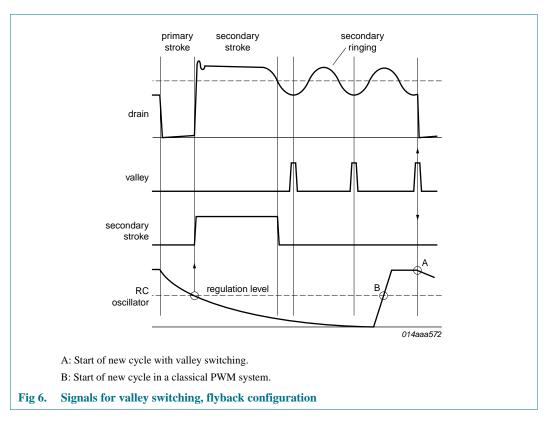
C_p = parasitic capacitance on drain node

Dimmable Greenchip driver for LED lighting

As soon as the oscillator voltage is high again and the secondary stroke has ended, the circuit waits for a low drain voltage before starting a new primary stroke.

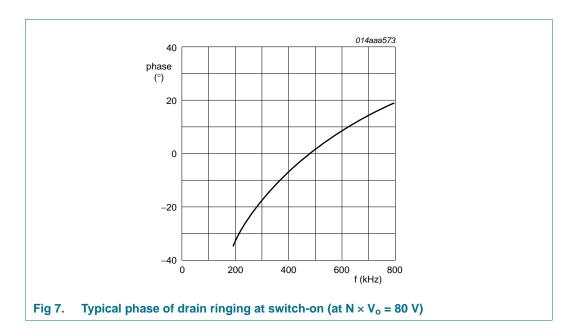
<u>Figure 6</u> shows the drain voltage together with the valley signal, the signal indicating the secondary stroke and the RC voltage.

The primary stroke starts some time before the actual valley at low ringing frequencies, and some time after the actual valley at high ringing frequencies.



<u>Figure 7</u> shows a typical curve for a reflected output voltage N at an output voltage of 80 V. This voltage is the output voltage transferred to the primary side of the transformer with the factor N (determined by the turns ratio of the transformer). It shows that the system switches exactly at minimum drain voltage for ringing frequencies of 480 kHz, thus reducing the switch-on losses to a minimum. At 200 kHz, the next primary stroke is started at 33° before the valley. The switch-on losses are still reduced significantly.

Dimmable Greenchip driver for LED lighting



8.6 Demagnetization

The system operates in discontinuous conduction mode if the AUX pin is connected. As long as the secondary stroke has not ended, the oscillator will not start a new primary stroke. During the first $t_{sup(xfmr_ring)}$ seconds, demagnetization recognition is suppressed. This suppression may be necessary in applications where the transformer has a large leakage inductance and at low output voltages.

8.7 Overcurrent protection

The cycle-by-cycle peak drain current limit circuit uses the external source resistor R_{SENSE} to measure the current. The circuit is activated after the leading edge blanking time $t_{\text{leb}}.$ The protection circuit limits the source voltage over the $R_{\text{SENSE}}{}^1$ resistor to $V_{\text{th(ocp)SOURCE}},$ and thus limits the primary peak current.

8.8 Short-winding protection

The short-winding protection circuit is also activated after the leading edge blanking time. If the source voltage exceeds the short-winding protection threshold voltage $V_{th(swp)SOURCE}$, the IC stops switching. Only a power-on reset will restart normal operation. The short-winding protection also protects in case of a secondary diode short circuit.

8.9 Overtemperature protection

Accurate temperature protection is provided in the device. When the junction temperature exceeds the thermal shut-down temperature, the IC stops switching. During thermal protection, the IC current is lowered to the start-up current. The IC continues normal operation as soon as the overtemperature situation has disappeared.

SL2101

^{1.} R_{SENSE} is the resistor between the SOURCE pin and GND

Dimmable Greenchip driver for LED lighting

9. Limiting values

Table 4: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). All voltages are measured with respect to ground; positive currents flow into the device; pins V_{CC} and RC cannot be current driven. Pins ISENSE and AUX cannot be voltage driven.

Symbol	Parameter	Conditions	Min	Max	Unit
Voltages					
V _{CC}	supply voltage	continuous	-0.4	+40	V
V_{RC}	voltage on pin RC		-0.4	+3	V
V _{RC2}	voltage on pin RC2		-0.4	+3	V
V _{BRIGHTNESS}	voltage on pin BRIGHTNESS		-0.4	+5	V
V _{PWMLIMIT}	voltage on pin PWMLIMIT		-0.4	+5	V
V _{SOURCE}	voltage on pin SOURCE		-0.4	+5	V
V_{DRAIN}	voltage on pin DRAIN	DMOS power transistor; T _{amb} = 25 °C	-0.4	+600	V
V _{SBLEED}	voltage on pin SBLEED	off-state; T _j = 125 °C	-0.4	+600	V
		on-state; $V_{VCC} > 8.5 V$; $T_j < 125 °C$	-0.4	+16	V
V_{WBLEED}	voltage on pin WBLEED	off-state; T _j < 125 °C	-0.4	+600	V
		on-state; $V_{VCC} > 8.5 \text{ V};$ $T_j < 125 ^{\circ}\text{C}$	-0.4	+12	V
Currents					
I _{ISENSE}	current on pin ISENSE		-20	+5	mA
I _{AUX}	current on pin AUX		-10	+5	mA
I _{SOURCE}	current on pin SOURCE		-2	+2	Α
I _{DRAIN}	current on pin DRAIN		-2	+2	Α
General					
P _{tot}	total power dissipation	$T_{amb} = 70 ^{\circ}C$	-	1	W
T_{stg}	storage temperature		-55	+150	°C
T _{amb}	ambient temperature		-40	+100	°C
T _j	junction temperature		-40	+150	°C

Dimmable Greenchip driver for LED lighting

Table 4: Limiting values ... continued

In accordance with the Absolute Maximum Rating System (IEC 60134). All voltages are measured with respect to ground; positive currents flow into the device; pins V_{CC} and RC cannot be current driven. Pins ISENSE and AUX cannot be voltage driven.

Symbol	Parameter	Conditions		Min	Max	Unit
V _{ESD}	electrostatic discharge voltage	human body model;	<u>[1]</u>			
		Pins 16, 1, 2		-1000	+1000	V
		All other pins		-2000	+2000	V
		machine model	[2]	-200	+200	V
		charged device model	[3]	-500	+500	V

- [1] Human body model: equivalent to discharging a 100 pF capacitor through a 1.5 k Ω series resistor.
- [2] Machine model: equivalent to discharging a 200 pF capacitor through a 0.75 μH coil and a 10 Ω series resistor.
- [3] Charged device model: equivalent to charging the IC up to 1 kV and the subsequent discharging of each pin down to 0 V over a 1 Ω resistor.

10. Thermal characteristics

The heat sink in the application with the SSL2101 is made with the copper on the Printed-Circuit Board (PCB). The SSL2101 uses thermal leads (pins 4, 5, 13, 14 and 15) for heat transfer from die to PCB.

Enhanced thermal lead connection may drastically reduce thermal resistance.

The following equation shows the relationship between the maximum allowable power dissipation P and the thermal resistance from junction to ambient.

$$R_{th(i-a)} = (T_{i(max)} - T_{amb})/P$$

Where:

 $R_{th(i-a)}$ = thermal resistance from junction to ambient

 $T_{i(max)}$ = maximum junction temperature

T_{amb} = ambient temperature

P = power dissipation

The thermal resistance as a function of the PCB area (Board: 0.8 mm thickness, 2 layers, Bottom Cu coverage 90 %, Cu thickness 70 μ m

(390 W/mK), Core material conductivity: 0.5 W/mK, 10 vias dia 0.3 mm) is shown in Figure 8

Dimmable Greenchip driver for LED lighting

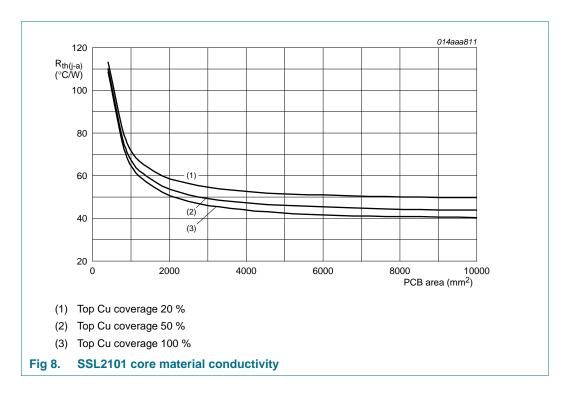


Table 5: Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient		<u>[1]</u> 90	KW

^[1] Measured on a JEDEC test board (standard EIA/JESD 51-3) in free air with natural convection.

11. Characteristics

Table 6: Characteristics

 T_{amb} = 25 °C; no overtemperature; all voltages are measured with respect to ground; currents are positive when flowing into the IC and PWMLIMIT and BRIGHTNESS pins are disconnected unless otherwise specified. Typical frequency 100 kHz.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supply						
Icc	supply current	normal operation; $V_{DRAIN} = 60 \text{ V};$ $V_{CC} = 20 \text{ V}$	-	1.7	2	mA
I _{CC(ch)}	charge supply current	$V_{DRAIN} > 60 \text{ V};$ $V_{CC} = 0 \text{ V}$	-6	-4.5	-	mA
V _{CC}	supply voltage		8.5	-	40	V
V _{CC(startup)}	start-up supply voltage		9.75	10.25	10.75	V
V _{CC(UVLO)}	undervoltage lockout supply voltage	L	7.9	8.2	8.5	V

Dimmable Greenchip driver for LED lighting

 Table 6:
 Characteristics ...continued

 T_{amb} = 25 °C; no overtemperature; all voltages are measured with respect to ground; currents are positive when flowing into the IC and PWMLIMIT and BRIGHTNESS pins are disconnected unless otherwise specified. Typical frequency 100 kHz.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{DRAIN}	current on pin DRAIN	V _{DRAIN} > 60 V; no auxiliary supply	-	-	2.2	mA
		V _{DRAIN} > 60 V; with auxiliary supply	-	30	125	μА
V_{DRAIN}	voltage on pin DRAIN		40	-	600	V
Pulse width me	odulator					
δ_{min}	minimum duty factor		-	0	-	%
δ_{max}	maximum duty cycle	f = 100 kHz	-	75	-	%
SOPS						
$V_{\text{det(demag)}}$	demagnetization detection voltage		50	100	150	mV
t _{sup(xfmr_ring)}	transformer ringing suppression time	at start of secondary stroke	1.0	1.5	2.0	μS
RC oscillator						
$V_{RC(min)}$	minimum voltage on pin RC		60	75	90	mV
V _{RC(max)}	maximum voltage on pin RC		2.4	2.5	2.6	V
t _{ch(RC)}	charge time on pin RC		-	1	-	μS
V _{BRIGHTNESS}	voltage on pin	2.5 V RC2 trip level	-	0.5	-	V
	BRIGHTNESS	180 mV RC2 trip level	-	1.25	-	V
		75 mV RC2 trip level	-	2.3	-	V
f _{osc}	oscillator frequency		10	100	200	kHz
I _{BRIGHTNESS}	current on pin BRIGHTNESS	V _{BRIGHTNESS} = 0 V	-20	-24	-28	μА
Bleeder						
$V_{th(SBLEED)}$	threshold voltage on pin SBLEED		46	52	56	V
$V_{th(low)}$ ISENSE	low threshold voltage on pin ISENSE		-	-250	-	mV
$V_{\text{th(high)}}$ ISENSE	high threshold voltage on pin ISENSE		-	-100	-	mV
R _{DSon(SBLEED)}	drain-source	$I_{SBLEED} = 25 \text{ mA}$				
	on-state resistance on pin	T _j = 25 °C	140	170	200	Ω
	SBLEED	T _j = 125 °C	220	270	320	Ω

Dimmable Greenchip driver for LED lighting

 Table 6:
 Characteristics ...continued

 T_{amb} = 25 °C; no overtemperature; all voltages are measured with respect to ground; currents are positive when flowing into the IC and PWMLIMIT and BRIGHTNESS pins are disconnected unless otherwise specified. Typical frequency 100 kHz.

$ \begin{array}{llllllllllllllllllllllllllllllllllll$	ax Unit	Max	Тур	Min		Conditions	Parameter	Symbol
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$						$I_{WBLEED} = 10 \text{ mA}$		R _{DSon(WBLEED)}
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	Ω 0	350	310	250		T _j = 25 °C		
PWMLIMIT Current on pin PWMLIMIT Voltage on pin PWMLIMIT Voltage on pin PWMLIMIT 3 V Voltage on pin Voltage change with time Value Voltage on pin Source on pin DRAIN Voltage	Ω 0	600	500	400		T _j = 125 °C	•	
PWMLIMIT Voltage on pin PWMLIMIT Voltage on pin PWMLIMIT Voltage on pin PWMLIMIT Threshold Valley switching Valley recognition voltage change with time Valley recognition to switch-on delay time Valley recognition threshold voltage on pin SOURCE Valley						VIIT	ulator: pin PWMLIN	Duty factor reg
PWMLIMIT 3 V minimum duty factor threshold - 0.45 - 0.4	8 μΑ	-18	-	-25				I _{PWMLIMIT}
Valley switching (ΔV/Δt) _{vrec} valley recognition voltage change with time value va	V	-	3	-				V _{PWMLIMIT}
	V	-	0.45	-				
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$							g	Valley switching
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	V/μs	-	100	1 -	[1]		voltage change	$(\Delta V/\Delta t)_{Vrec}$
	0 kHz	800	550	200		$N \times V_O = 100 V$	ringing frequency	f _{ring}
$V_{th(ocp)SOURCE} \begin{array}{c} \text{overcurrent} \\ \text{protection} \\ \text{threshold voltage} \\ \text{on pin SOURCE} \\ \end{array} \begin{array}{c} \text{short-winding} \\ \text{protection} \\ \text{threshold voltage} \\ \text{on pin SOURCE} \\ \end{array} \begin{array}{c} \text{short-winding} \\ \text{protection} \\ \text{threshold voltage} \\ \text{on pin SOURCE} \\ \end{array} \begin{array}{c} \text{dV/dt} = 0.1 \text{ V/}\mu\text{s} \\ \end{array} \begin{array}{c} - \\ \text{1.5} \\ \end{array} \begin{array}{c} - \\ \text{short-winding} \\ \text{protection} \\ \text{threshold voltage} \\ \text{on pin SOURCE} \\ \end{array} \begin{array}{c} \text{dV/dt} = 0.5 \text{ V/}\mu\text{s} \\ \end{array} \begin{array}{c} - \\ \text{160} \\ \end{array} \begin{array}{c} 185 \\ \text{350} \\ \end{array} \begin{array}{c} - \\ \text{350} \\ \end{array} \begin{array}{c} 160 \\ \text{350} \\ \end{array} \begin{array}{c} 185 \\ \text{350} \\ \end{array} \begin{array}{c} \text{FET output stage} \\ \\ \text{IL_(DRAIN)} \begin{array}{c} \text{leakage current on pin DRAIN} \\ \text{pin DRAIN} \\ \end{array} \begin{array}{c} V_{DRAIN} = 600 \text{ V} \\ \text{pin DRAIN} \\ \end{array} \begin{array}{c} - \\ \text{125} \\ \text{ONSON} \\ \end{array} \begin{array}{c} \text{drain-source} \\ \text{on-state} \\ \text{resistance} \\ \end{array} \begin{array}{c} \text{power switch;} \\ \text{I}_{SOURCE} = -0.50 \text{ A} \\ \end{array} \begin{array}{c} - \\ \text{I}_{SOURCE} = -0.20 \text{ A} \\ \end{array} \begin{array}{c} \text{4.50} 6.5 \\ \text{7.5} \\ \end{array} \begin{array}{c} \text{3.50} \\ \text{3.50} \\ \end{array} \begin{array}{c} \text{3.50} \\ $	ns	-	150	-			to switch-on delay	t _{d(vrec-swon)}
$V_{th(swp)SOURCE} \\ V_{th(swp)SOURCE} \\ V_{th(swp)SOURCE} \\ Short-winding protection threshold voltage on pin SOURCE} \\ V_{th(swp)SOURCE} \\ V_{t$						protection	ort circuit winding	Current and sh
protection threshold voltage on pin SOURCE $t_{d(ocp\text{-swoff})} delay time from overcurrent protection to switch-off t_{leb} leading edge blanking time \\ \hline \textbf{FET output stage} \\ \hline \textbf{I}_{L(DRAIN)} leakage current on pin DRAIN \\ \hline \textbf{V}_{BR(DRAIN)} breakdown voltage on pin DRAIN \\ \hline \textbf{R}_{DSon} drain-source on-state resistance} \begin{array}{c} power switch; \\ lsource = -0.50 \text{ A} \\ \hline \textbf{T}_j = 25 \text{ °C} \\ \hline \textbf{SOURCE} = -0.20 \text{ A} \\ \end{array} $	53 V	0.53	0.50	0.47		$dV/dt = 0.1 V/\mu s$	protection threshold voltage	V _{th(ocp)} SOURCE
$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	V	-	1.5	-		$dV/dt = 0.1 V/\mu s$	protection threshold voltage	$V_{th(swp)}$ SOURCE
blanking time	5 ns	185	160	-		$dV/dt = 0.5 V/\mu s$	overcurrent protection to	t _{d(ocp-swoff)}
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	0 ns	450	350	250				t _{leb}
$\begin{array}{c} \text{pin DRAIN} \\ \text{V}_{\text{BR(DRAIN)}} \\ \text{breakdown} \\ \text{voltage on pin DRAIN} \\ \\ \text{R}_{\text{DSon}} \\ \text{drain-source} \\ \text{on-state} \\ \text{resistance} \\ \end{array} \begin{array}{c} \text{power switch;} \\ \text{I}_{\text{SOURCE}} = -0.50 \text{ A} \\ \\ \hline \text{T}_{j} = 25 \text{ °C} \\ \hline \text{I}_{\text{SOURCE}} = -0.20 \text{ A} \\ \end{array}$							ge	FET output stag
$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	25 μΑ	125	-	-		$V_{DRAIN} = 600 \text{ V}$		I _{L(DRAIN)}
on-state resistance $I_{SOURCE} = -0.50 \text{ A}$ $T_{j} = 25 \text{ °C} \qquad 4.50 6.5 7.5$ $I_{SOURCE} = -0.20 \text{ A}$	V	-	-	600		T _{amb} = 25 °C	voltage on pin	V _{BR(DRAIN)}
$I_{\text{SOURCE}} = -0.20 \text{ A}$							on-state	R _{DSon}
	5 Ω	7.5	6.5	4.50		T _j = 25 °C	resistance	
$T_j = 125 ^{\circ}C$ - 9.5 10						$I_{SOURCE} = -0.20 \text{ A}$		
	Ω	10	9.5	-		T _j = 125 °C		

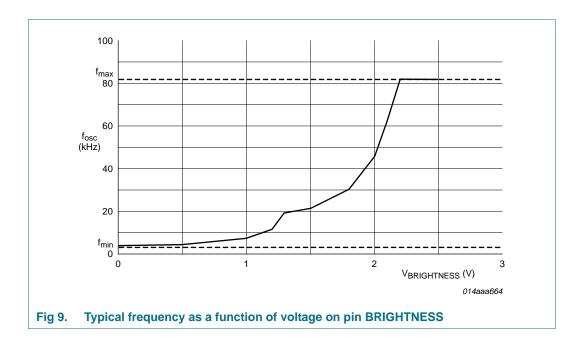
Dimmable Greenchip driver for LED lighting

 Table 6:
 Characteristics ... continued

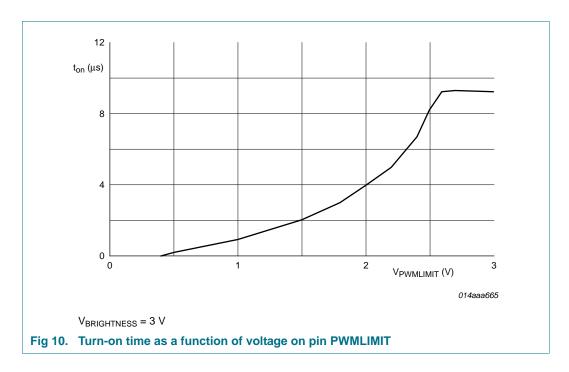
 T_{amb} = 25 °C; no overtemperature; all voltages are measured with respect to ground; currents are positive when flowing into the IC and PWMLIMIT and BRIGHTNESS pins are disconnected unless otherwise specified. Typical frequency 100 kHz.

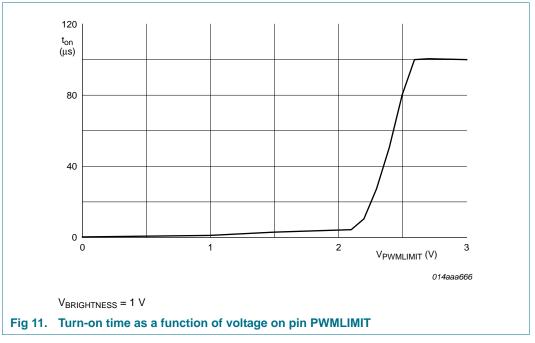
Symbol	Parameter	Conditions	Min	Тур	Max	Unit				
$t_{f(DRAIN)}$	fall time on pin DRAIN	input voltage: 300 V; no external capacitor at drain	-	75	-	ns				
Temperature protection										
T _{otp}	overtemperature protection trip	junction temperature	150	160	170	°C				
T _{otp(hys)}	overtemperature protection trip hysteresis	junction temperature	-	2	-	°C				

[1] Voltage change in time for valley recognition.



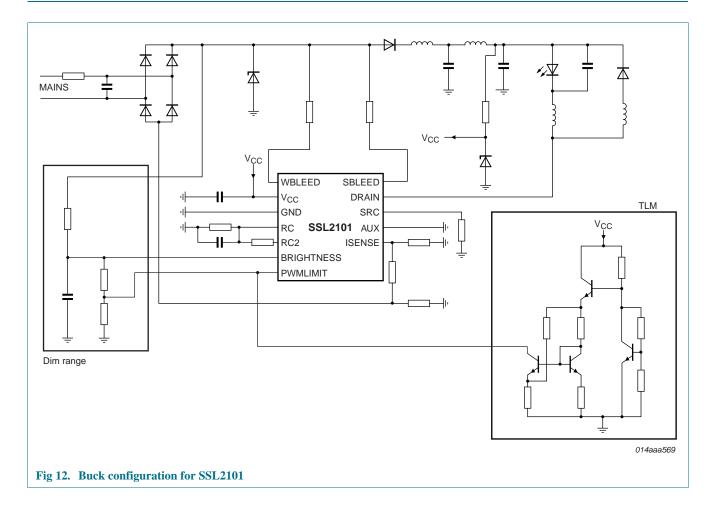
Dimmable Greenchip driver for LED lighting



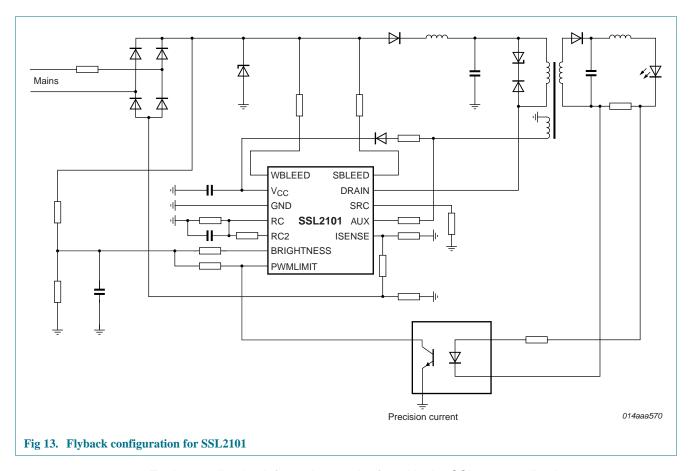


Dimmable Greenchip driver for LED lighting

12. Application information



Dimmable Greenchip driver for LED lighting



Further application information can be found in the SSL2101 application notes.

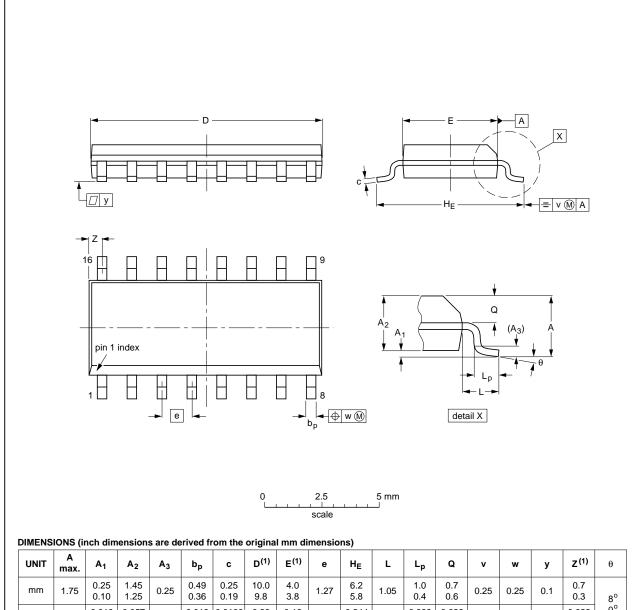
SSL2101 NXP Semiconductors

Dimmable Greenchip driver for LED lighting

13. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01	l	0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012				99-12-27 03-02-19
			•			

Fig 14. Package outline SOT109-1 (SO16)

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2011. All rights reserved.

Dimmable Greenchip driver for LED lighting

14. Revision history

Table 7: Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
SSL2101 v.4.1	20111205	Product data sheet	-	SSL2101 v.4	
Modifications:	 GreenChip trademark has been added. Section 1 "General description" has been updated. Section 2 "Features and benefits" has been updated. Section 3 "Applications" has been updated. 				
SSL2101 v.4	20090828	Product data sheet	-	SSL2101 v.3	
SSL2101 v.3	20090525	Product data sheet	-	SSL2101 v.2	
SSL2101 v.2	20090511	Preliminary data sheet	-	SSL2101 v.1	
SSL2101 v.1	20090109	Preliminary data sheet	-	-	

Dimmable Greenchip driver for LED lighting

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

15.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

15.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or

malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

SSL2101

Dimmable Greenchip driver for LED lighting

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b)

whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

GreenChip — is a trademark of NXP B.V.

16. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

SSL2101 NXP Semiconductors

Dimmable Greenchip driver for LED lighting

17. Contents

1	General description	. 1
2	Features and benefits	. 1
3	Applications	. 1
4	Quick reference data	. 2
5	Ordering information	. 2
6	Block diagram	. 3
7	Pinning information	. 4
7.1	Pinning	. 4
7.2	Pin description	. 4
8	Functional description	. 5
8.1	Start-up and UnderVoltage LockOut (UVLO) .	. 5
8.2	Oscillator	
8.3	Duty factor control	
8.4	Bleeder for dimming applications	
8.5	Valley switching	
8.6	Demagnetization	
8.7	Overcurrent protection	
8.8	Short-winding protection	
8.9	Overtemperature protection	
9	Limiting values	
10	Thermal characteristics	11
11	Characteristics	12
12	Application information	17
13	Package outline	19
14	Revision history	20
15	Legal information	21
15.1	Data sheet status	21
15.2	Definitions	21
15.3	Disclaimers	21
15.4	Trademarks	22
16	Contact information	22
17	Contents	23

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.